



Product Change Notification

Change Notification #: 118415-00
Change Title: Select Intel® Dual Band Wireless-AC 3168 Series,
PCN 118415-00, Label,
Label updates
Date of Publication: August 5, 2021

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 01, 2021
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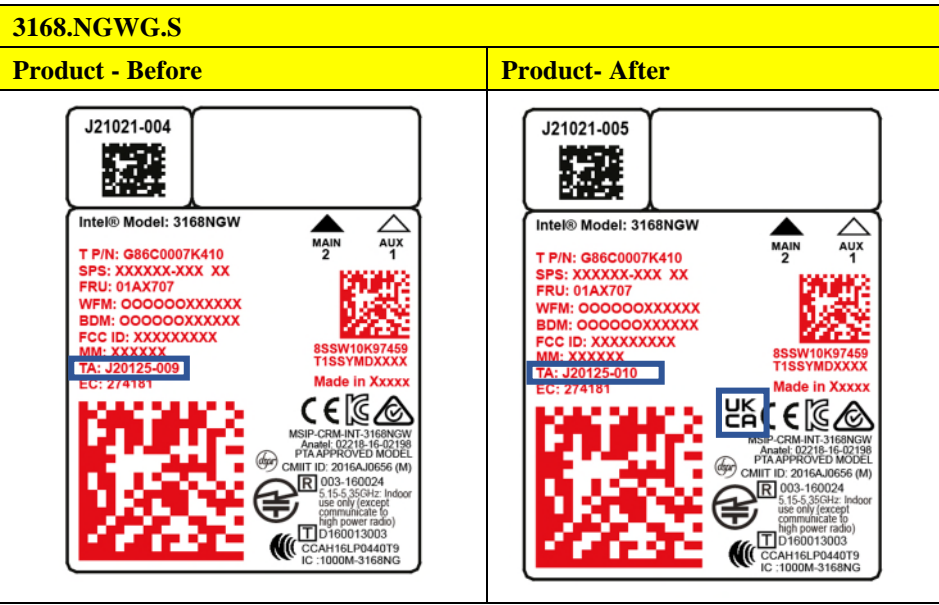
Description of Change to the Customer:

The Intel® Dual Band Wireless -AC3168 2230 SKUs listed in the products affected table below will undergo the following changes.







1. Update UK/Brexit table on Disti label.
2. Add UKCA logo on both product and disti label.
3. The Intel Tracking revision will be changed on the following products.

Product Code	Before	After
3168.NGWG	0J	0K







4. Product TA# dash up



Disti Label - Before

<p>3168.NGWS.S</p>  <p>VERSION # J20125-009</p>  <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p>	<p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>	<p>QTY: 100</p>   <p>1 88334 00140 2</p>  <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 3168 (Model: 3168NGW)</p> <p>PKG ID (3S) VVVVMMMMDDDD####PPPPPP100</p> <p>T P/N: G86C0007K410</p> <p>D P/N: P P P P P P REV AX X HP P/N: XXXXX-XXX REV: XX</p> <p>Vendor ID Loc Id Mfg Id L P/N: SW10K97459</p> <p>VVVVVLLLLL M M M M M EC: 274181</p> <p>PACKAGE WEIGHT: XX LBS</p>	 <table border="1" style="font-size: 8px; border-collapse: collapse;"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>MSIP-CRM-INT-3168NGW</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
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LV	MT	NL	PL	PT	RO	SE																																	
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Disti Label - After

<p>3168.NGWS.S</p>  <p>VERSION # J20125-010</p>  <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p>	<p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>	<p>QTY: 100</p>   <p>1 88334 00140 2</p>  <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 3168 (Model: 3168NGW)</p> <p>PKG ID (3S) VVVVMMMMDDDD####PPPPPP100</p> <p>T P/N: G86C0007K410</p> <p>D P/N: P P P P P P REV AX X HP P/N: XXXXX-XXX REV: XX</p> <p>Vendor ID Loc Id Mfg Id L P/N: SW10K97459</p> <p>VVVVVLLLLL M M M M M EC: 274181</p> <p>PACKAGE WEIGHT: XX LBS</p>	 <table border="1" style="font-size: 8px; border-collapse: collapse;"> <tr><td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td></tr> <tr><td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td></tr> <tr><td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td></tr> <tr><td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td></tr> <tr><td>SI</td><td>SK</td><td>TR</td><td>UK(N)</td><td></td><td></td><td></td></tr> </table> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>MSIP-CRM-INT-3168NGW</p>	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK(N)			
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Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Post Change TA
Intel® Dual Band Wireless-AC 3168, 1x1 AC + BT M.2 2230, No vPro®	3168.NGWG	944884	J20109-010	J20109-011
Intel® Dual Band Wireless-AC 3168, 1x1 AC + BT M.2 2230, Low Power, No vPro®	3168.NGWG.S	944885	J20125-009	J20125-010

PCN Revision History:

Date of Revision:

August 5, 2021

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

118415-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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